

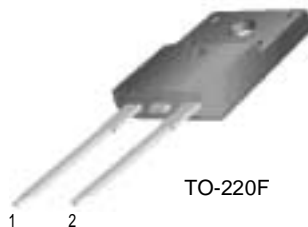
FFPF14X150S

Features

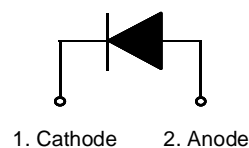
- High voltage and high reliability
- High speed switching
- Low forward voltage

Applications

- Suitable for damper diode in horizontal deflection circuits



TO-220F



DAMPER DIODE

Absolute Maximum Ratings $T_C=25^\circ\text{C}$ unless otherwise noted

| Symbol | Parameter | Value | Units |
|----------------|---|--------------|------------------|
| V_{RRM} | Peak Repetitive Reverse Voltage | 1500 | V |
| $I_{F(AV)}$ | Average Rectified Forward Current @ $T_C = 125^\circ\text{C}$ | 14 | A |
| I_{FSM} | Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave | 140 | A |
| T_J, T_{STG} | Operating Junction and Storage Temperature | - 65 to +150 | $^\circ\text{C}$ |

Thermal Characteristics

| Symbol | Parameter | Value | Units |
|-----------------|--|-------|--------------------|
| $R_{\theta JC}$ | Maximum Thermal Resistance, Junction to Case | 1.5 | $^\circ\text{C/W}$ |

Electrical Characteristics $T_C=25^\circ\text{C}$ unless otherwise noted

| Symbol | Parameter | Min. | Typ. | Max. | Units | |
|------------|---|---------------------------|------|------|-------|---------------|
| V_{FM}^* | Maximum Instantaneous Forward Voltage $I_F = 14\text{A}$ | $T_C = 25^\circ\text{C}$ | - | - | 2.4 | V |
| | | $T_C = 125^\circ\text{C}$ | - | - | 2.1 | |
| I_{RM}^* | Maximum Instantaneous Reverse Current @ rated V_R | $T_C = 25^\circ\text{C}$ | - | - | 20 | μA |
| | | $T_C = 125^\circ\text{C}$ | - | - | 300 | |
| t_{rr} | Maximum Reverse Recovery Time ($I_F = 1\text{A}$, $di/dt = 50\text{A}/\mu\text{s}$) | - | - | 120 | ns | |
| t_{fr} | Maximum Forward Recovery Time ($I_F = 6.5\text{A}$, $di/dt = 50\text{A}/\mu\text{s}$) | - | - | 290 | ns | |
| V_{FRM} | Maximum Forward Recovery Voltage | - | - | 13 | V | |

* Pulse Test: Pulse Width=300 μs , Duty Cycle=2%

Typical Characteristics

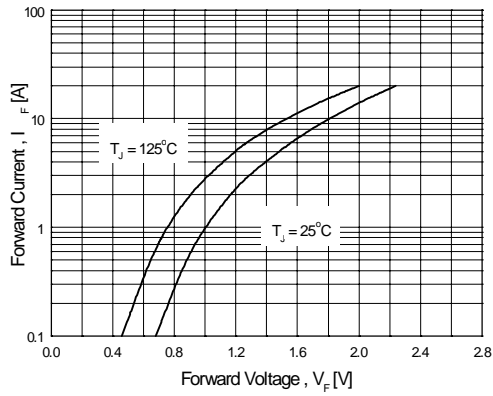


Figure 1. Typical Forward Voltage Drop vs. Forward Current

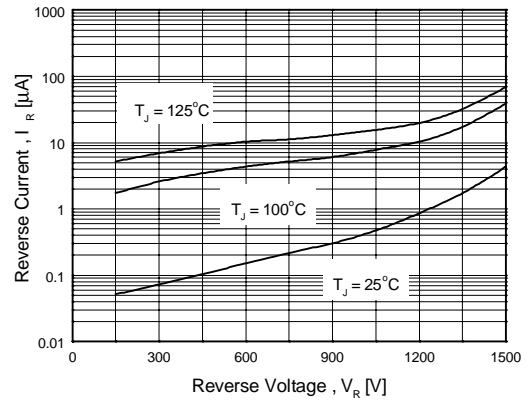


Figure 2. Typical Reverse Current vs. Reverse Voltage

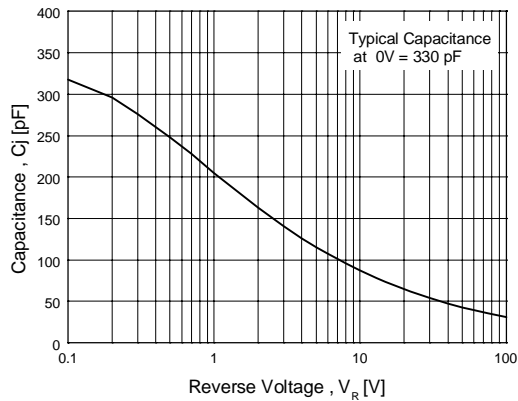


Figure 3. Typical Junction Capacitance

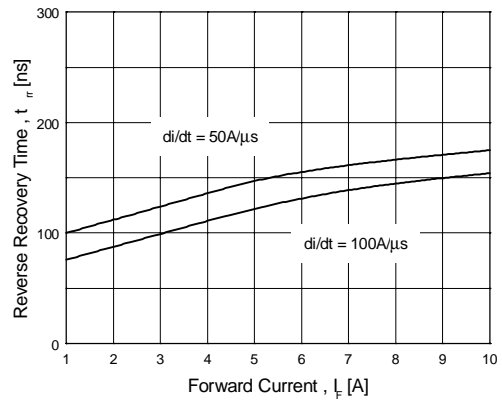


Figure 4. Typical Reverse Recovery Time vs. Forward Current

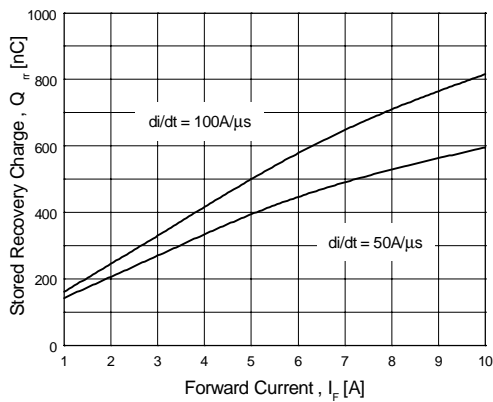


Figure 5. Typical Stored Charge vs. Forward Current

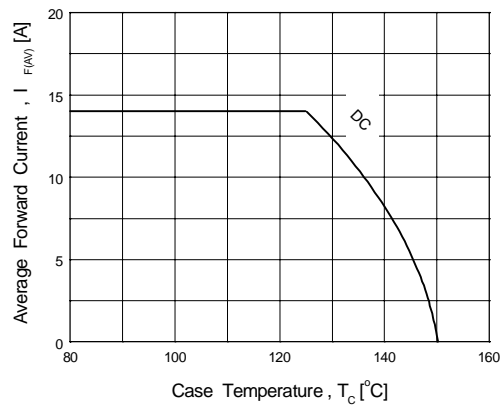


Figure 6. Forward Current Derating Curve

Package Dimensions

FFPF14X150S

TO-220F 2L



Dimensions in Millimeters

TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

| | | | |
|-----------------------------------|----------------------------------|----------------------------------|-------------------|
| ACE ^x TM | FAST ^r TM | QFET TM | VCX TM |
| Bottomless TM | GlobalOptoisolator TM | QS TM | |
| CoolFET TM | GTO TM | QT Optoelectronics TM | |
| CROSSVOLT TM | HiSeC TM | Quiet Series TM | |
| DOME TM | ISOPLANAR TM | SuperSOT TM -3 | |
| E ² CMOS TM | MICROWIRE TM | SuperSOT TM -6 | |
| EnSigna TM | OPTOLOGIC TM | SuperSOT TM -8 | |
| FACT TM | OPTOPLANAR TM | SyncFET TM | |
| FACT Quiet Series TM | POP TM | TinyLogic TM | |
| FAST [®] | PowerTrench [®] | UHC TM | |

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

| Datasheet Identification | Product Status | Definition |
|--------------------------|------------------------|---|
| Advance Information | Formative or In Design | This datasheet contains the design specifications for product development. Specifications may change in any manner without notice. |
| Preliminary | First Production | This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design. |
| No Identification Needed | Full Production | This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design. |
| Obsolete | Not In Production | This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only. |